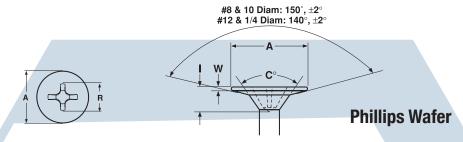
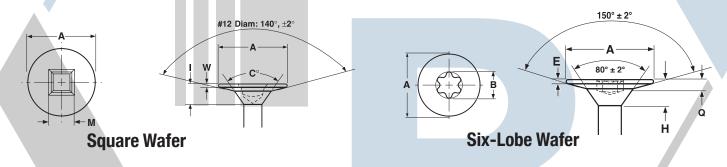
HEAD DIMENSIONS

Wafer: Phillips, Square & Six-Lobe Recess



WAFER PHILLIPS HEAD FOR SELF-DRILLING SCREWS									
Nominal Size	A		R		I	w		Bottom	Phillips Driver Size
	Head Diameter		Recess Diameter		Recess Depth	Wafer Thickness		Countersink Angle	
	Max.	Min.	Max	Min	Ref.	Max	Min	± 2°	
8	.380	.359	.189	.176	.255	.035	.025	50°	2
10	.516	.441	.204	.190	.322	.040	.031	80°	2
12	.552	.511	.268	.254	.377	.040	.031	70°	3
1/4	.620	.580	.282	.267	.160	.042	.033	70°	3

NOTE: There is no single standard for Wafer head dimensions. These values are offered as a guide; deviations from these specifications may occur



Wafer Square Recess Head for Self-Drilling Screws										
Nominal Size	A		М	1		w		С	Phillips Driver Size	
	Head Diameter		Recess Width	Recess Depth		Wafer Thickness		Bottom Countersink Angle		
	Max.	Min.	Ref	Max	Min	Max	Min	± 2°		
12	.551	.512	.133	.095	.080	.039	.031	70°	3	

NOTE: There is no single standard for Wafer head dimensions. These values are offered as a guide; deviations from these specifications may occur

WAFER SIX-LOBE HEAD FOR SELF-DRILLING SCREWS										
Nominal Size	A	١	В	Н	W					
	Head Diameter		Recess Diameter	Total Head Height	Wafer Thickness		Six-Lobe Recess Size			
	Max.	Min.	Ref	Ref.	Max	Min				
10	.516	.441	.155	.150	.040	.031	TX-20			

NOTE: There is no single standard for Wafer head dimensions. These values are offered as a guide; deviations from these specifications may occur